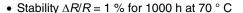






### **FEATURES**





• Pure tin solder contacts on Ni barrier layer provides compatibility with lead (Pb)-free and lead containing soldering processes

- Metal glaze on high quality ceramic
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition
- AEC-Q200 qualified

STANDARD	ELEC	TRICAL	SPECIFICATIO	NS					
MODEL	SIZE		RATED DISSIPATION	LIMITING ELEMENT VOLTAGE	TEMPERATURE COEFFICIENT	TOLERANCE	RESISTANCE RANGE	SERIES	
	INCH	METRIC	<i>P</i> <sub>70</sub> °c W	U <sub>max.</sub> AC/DC	ppm/K	70	Ω		
D10/CRCW0402	0402	RR 1005M	0.063	50	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24	
			Zero-Ohm-Resistor	$R_{\text{max.}} = 20 \text{ m}\Omega$	, I <sub>max.</sub> at 70 °C = 1.	5 A			
D11/CRCW0603	0603	RR 1608M	0.10	75	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24	
			Zero-Ohm-Resistor	$R_{\text{max.}} = 20 \text{ m}\Omega$	$I_{max.}$ at 70 °C = 2.	0 A			
D12/CRCW0805	0805	RR 2012M	0.125	150	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24	
			Zero-Ohm-Resistor: $R_{\text{max.}} = 20 \text{ m}\Omega$ , $I_{\text{max.}}$ at 70 °C = 2.5 A						
D25/CRCW1206	1206	RR 3216M	0.25	200	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24	
			Zero-Ohm-Resistor	$R_{\text{max.}} = 20 \text{ m}\Omega$	$I_{\text{max.}}$ at 70 °C = 3.	5 A			
CRCW1210	1210	RR 3225M	0.5	200	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24	
			Zero-Ohm-Resistor: $R_{\text{max.}} = 20 \text{ m}\Omega$ , $I_{\text{max.}}$ at 70 °C = 5.0 A						
CRCW1218	1218	RR 3246M	1.0	200	± 100 ± 200	± 1 ± 5	1R0 to 2M2	E24; E96 E24	
			Zero-Ohm-Resistor: $R_{\text{max.}}$ = 20 m $\Omega$ , $I_{\text{max.}}$ at 70 °C = 7.0 A						
CRCW2010	2010	RR 5025M	0.75	400	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24	
			Zero-Ohm-Resistor	$: R_{\text{max.}} = 20 \text{ m}\Omega$	$I_{\text{max.}}$ at 70 °C = 6.	0 A			
CRCW2512	2512	RR 6332M	1.0	500	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24	
			Zero-Ohm-Resistor	$R_{\text{max.}} = 20 \text{ m}\Omega$	$I_{\text{max.}}$ at 70 °C = 7.	0 A	_	•	

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- Marking: See data sheet "Surface Mount Resistor Marking" (document number 20020).
- Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.

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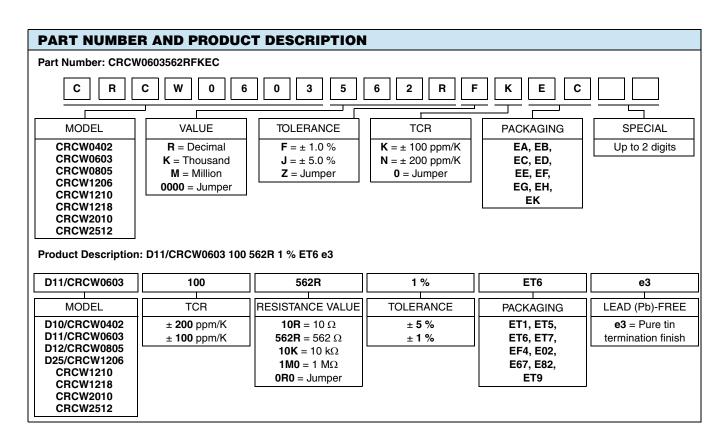
## Standard Thick Film Chip Resistors



TECHNICAL SPECIFICATIONS									
PARAMETER	UNIT	D10/ CRCW0402	D11/ CRCW0603	D12/ CRCW0805	D25/ CRCW1206	CRCW1210	CRCW1218	CRCW2010	CRCW2512
Rated dissipation $P_{70}$ <sup>(1)</sup>	W	0.063	0.1	0.125	0.25	0.5	1.0	0.75	1.0
Limiting element voltage $U_{\rm max.}$ AC/DC	V	50	75	150	200	200	200	400	500
Insulation voltage <i>U</i> <sub>ins</sub> (1 min)	V	> 75	> 100	> 200	> 300	> 300	> 300	> 300	> 300
Insulation resistance	Ω	> 10 <sup>9</sup>							
Category temperature range	°C	C - 55 to + 155							
Failure rate	h <sup>-1</sup>	< 0.1 x 10 <sup>-9</sup>							
Weight	mg	0.65	2	5.5	10	16	29.5	25.5	40.5

#### Note

<sup>(1)</sup> The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

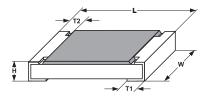


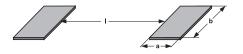




PACKAGING									
MODEL	UNIT	AC	PAPER TAPE ON CC. TO IEC 60286		BLISTER TAPE ON REEL ACC. TO IEC 60286-3, TYPE II				
		QUANTITY	PART NUMBER	PRODUCT DESC.	QUANTITY	PART NUMBER	PRODUCT DESC.		
D10/CRCW0402	180 mm/7"	10 000	ED	ET7					
D10/ChCVV0402	330 mm/13"	50 000	EE	EF4					
	180 mm/7"	5000	EA	ET1					
D11/CRCW0603	285 mm/11.25"	10 000	EB	ET5					
	330 mm/13"	20 000	EC	ET6					
	180 mm/7"	5000	EA	ET1					
D12/CRCW0805	285 mm/11.25"	10 000	EB	ET5					
	330 mm/13"	20 000	EC	ET6					
	180 mm/7"	5000	EA	ET1					
D25/CRCW1206	285 mm/11.25"	10 000	EB	ET5					
	330 mm/13"	20 000	EC	ET6					
	180 mm/7"	5000	EA	ET1					
CRCW1210	285 mm/11.25"	10 000	EB	ET5					
	330 mm/13"	20 000	EC	ET6					
CRCW1218	180 mm/7"				4000	EK	ET9		
CRCW2010	180 mm/7"				4000	EF	E02		
CRCW2512	180 mm/7"				2000	EG	E67		
On0W2312	180 mm/7*				4000	EH	E82		

### **DIMENSIONS**

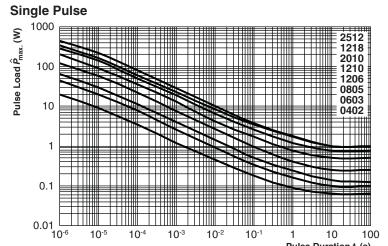




	175	DIMENSIONS in millimeters						SOLDER PAD DIMENSIONS in millimeters						
SIZE DIMENS				SIONS III IIIIII	III IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII			REFLOW SOLDERING			WAVE SOLDERING			
INCH	METRIC	L	W	Н	T1	T2	а	b	ı	а	b	- 1		
0402	1005	1.0 ± 0.05	$0.5 \pm 0.05$	$0.35 \pm 0.05$	$0.25 \pm 0.05$	$0.2 \pm 0.1$	0.4	0.6	0.5					
0603	1608	1.55 + 0.10	0.85 ± 0.1	$0.45 \pm 0.05$	$0.3 \pm 0.2$	$0.3 \pm 0.2$	0.5	0.9	1.0	0.9	0.9	1.0		
0805	2012	2.0 + 0.20 - 0.10	1.25 ± 0.15	0.45 ± 0.05	0.3 + 0.20 - 0.10	$0.3 \pm 0.2$	0.7	1.3	1.2	0.9	1.3	1.3		
1206	3216	3.2 + 0.10	1.6 ± 0.15	$0.55 \pm 0.05$	$0.45 \pm 0.2$	$0.4 \pm 0.2$	0.9	1.7	2.0	1.1	1.7	2.3		
1210	3225	$3.2 \pm 0.2$	2.5 ± 0.2	$0.55 \pm 0.05$	$0.45 \pm 0.2$	$0.4 \pm 0.2$	0.9	2.5	2.0	1.1	2.5	2.2		
1218	3246	3.2 + 0.10	4.6 ± 0.15	$0.55 \pm 0.05$	0.45 ± 0.2	$0.4 \pm 0.2$	1.05	4.9	1.9	1.25	4.8	1.9		
2010	5025	5.0 ± 0.15	2.5 ± 0.15	0.6 ± 0.1	$0.6 \pm 0.2$	$0.6 \pm 0.2$	1.0	2.5	3.9	1.2	2.5	3.9		
2512	6332	$6.3 \pm 0.2$	3.15 ± 0.15	$0.6 \pm 0.1$	$0.6 \pm 0.2$	$0.6 \pm 0.2$	1.0	3.2	5.2	1.2	3.2	5.2		



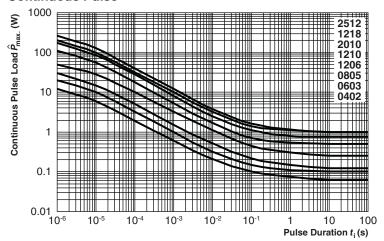
### **FUNCTIONAL PERFORMANCE**



Maximum pulse load, single pulse; applicable if  $\bar{P} \longrightarrow 0$  and n < 1000 and  $\hat{U} \leq \hat{U}_{max}$ ; for permissible resistance change equivalent to 8000 h operation

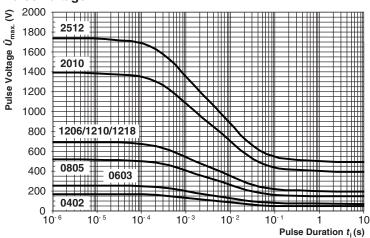
Pulse Duration  $t_i$  (s)

### **Continuous Pulse**



Maximum pulse load, continuous pulses; applicable if  $\bar{P} \leq P$  ( $\vartheta_{amb}$ ) and  $\hat{U} \leq \hat{U}_{max}$ ; for permissible resistance change equivalent to 8000 h operation

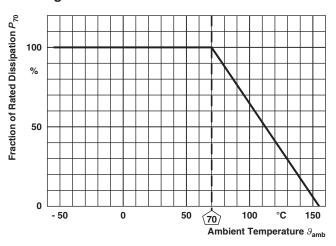
### **Pulse Voltage**



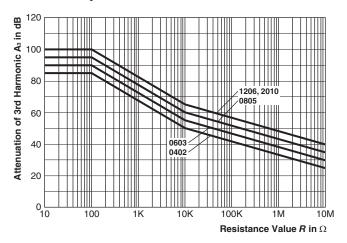
Maximum pulse voltage, single and continuous pulses; applicable if  $\hat{P} \le \hat{P}_{max.}$ ; for permissible resistance change equivalent to 8000 h operation



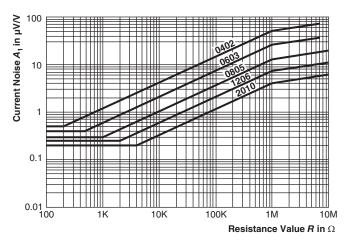
### **Derating**



### **Non-Linearity**



### **Current Noise**





				REQUIREMENTS PERMISSIBLE CHANGE ( $\Delta R$ ) SIZE 0402 to 2512				
EN	IEC 60068-2		_					
60115-1 CLAUSE	TEST METHOD	TEST	PROCEDURE	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER			
		Stability for product types:						
			D/CRCW e3	1 $\Omega$ to 10 M $\Omega$				
4.5	-	Resistance	-	± 1 %	± 5 %			
4.7	-	Voltage proof	$U = 1.4 \text{ x } U_{\text{ins}}; 60 \text{ s}$	No flashover o	r breakdown			
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\text{max.}};$ duration: Acc. to style	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$			
4.17.0			Solder bath method; Sn60Pb40 non activated flux; (235 ± 5) °C (2 ± 0.2) s	Good tinning (≥ 95 % covered) no visible damage				
4.17.2 58 (Td) Solderability		Solderability	Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; (245 ± 5) °C (3 ± 0.3) s	Good tinning (≥ 95 % covered) no visible damage				
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K	± 200 ppm/K			
4.32	21 (Uu <sub>3</sub> )	Shear (adhesion)	RR 1608 and smaller: 9 N RR 2012 and larger: 45 N	No visible	damage			
4.33	21 (Uu <sub>1</sub> )	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm$ (0.25 % $R$ + 0.05 $\Omega$ )				
4.19	14 (Na)	Rapid change of temperature	30 min. at - 55 °C; 30 min. at 125 °C 5 cycles 1000 cycles	$\pm$ (0.25 % R + 0.05 Ω) $\pm$ (1 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω) ± (1 % R + 0.05 Ω)			
4.23	-	Climatic sequence:	-	,	,			
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h					
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 1 cycle					
4.23.4	1 (Aa)	Cold	- 55 °C; 2 h	$\pm (1 \% R + 0.05 \Omega)$	$\pm$ (2 % $R$ + 0.1 $\Omega$ )			
4.23.5	13 (M)	Low air pressure	1 kPa; (25 ± 10) °C; 1 h					
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycles					
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R}$					
4.05.3		Endurance	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1.5 h on; 0.5 h off;					
4.25.1	-	at 70 °C	70 °C; 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)			
			70 °C; 8000 h	± (2 % R + 0.1 Ω) ± (4 % R				



TEST PROCEDURES AND REQUIREMENTS									
	IEC			REQUIREMENTS PERMISSIBLE CHANGE ( $\Delta R$ )					
EN 60115-1	60068-2	TEST	PROCEDURE	SIZE 0402 to 2512					
CLAUSE	TEST METHOD	1231	PHOCESONE	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER				
			Stability for product types:						
			D/CRCW e3	1 Ω to 1	0 ΜΩ				
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method $(260 \pm 5)$ °C; $(10 \pm 1)$ s	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)				
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning	after 30 s				
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (1 % <i>R</i> +	0.05 Ω)				
4.25.3	ı	Endurance at upper category temperature	155 °C, 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				
4.40	4.40 - Electrostatic discharge (human body model)		IEC 61340-3-1; 3 pos. + 3 neg. discharges; ESD voltage acc. to size	± (1 % <i>R</i> + 0.05 Ω)					
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible	damage				
4.30	4.30 45 (XA) Solvent resistance of marking		Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking I no visible					
4.22	6 (Fc)	Vibration, endurance by sweeping	$f = 10 \text{ Hz to } 2000 \text{ Hz}; \\ x, y, z \le 1.5 \text{ mm}; \\ A \le 200 \text{ m/s}^2; \\ 10 \text{ sweeps per axis}$	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)				
4.37	.37 - Periodic electric overload		$U = \sqrt{15 \times P_{70} \times R}$ $\leq 2 \times U_{\text{max.}};$ 0.1 s on; 2.5 s off; 1000 cycles	± (1 % R + 0.05 Ω)					
Single pulse high voltage overload, 10 µs/700 µs		$\hat{U} = 10 \text{ x } \sqrt{P_{70} \text{ x } R}$ $\leq 2 \text{ x } U_{\text{max.}};$ $10 \text{ pulses}$	± (1 % <i>R</i> + 0.05 Ω)						

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.





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